



40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	Qg Typ	I _D T _C = +25°C (Note 10)	
40V	$3.2m\Omega$ @ $V_{GS} = 10V$	68.6nC	100A	

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Qg Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC/DC Converters

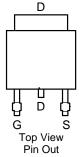
Mechanical Data

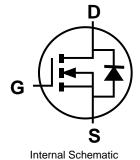
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)





Top View





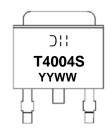
Ordering Information (Note 5)

Part Number	Case	Packaging
DMTH4004SK3Q-13	TO252 (DPAK)	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T4004S = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 16 = 2016)
WW = Week Code (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	40	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 7)	T _C = +25°C (Note 10)	ID	100	А	
·	T _C = +100°C	_	100		
Maximum Body Diode Forward Current (Note 7)	Is	100	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	160	Α		
Avalanche Current, L=0.2mH	I _{AS}	40	Α		
Avalanche Energy, L=0.2mH	E _{AS}	160	mJ		

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	3.9	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{ heta JA}$	38	°C/W
Total Power Dissipation (Note 7) $T_C = +25^{\circ}C$		PD	180	W
Thermal Resistance, Junction to Case (Note 7)		R _θ JC	0.8	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

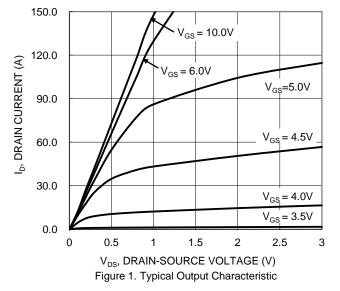
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		2.6	3.2	mΩ	$V_{GS} = 10V, I_D = 90A$	
Diode Forward Voltage	V_{SD}		0.9	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	4,305	_			
Output Capacitance	Coss		1,441	_	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$	
Reverse Transfer Capacitance	Crss		102	_			
Gate Resistance	R_G		0.77	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g	_	68.6	_	V 20V I 20A		
Gate-Source Charge	Qgs	_	16.8	_	nC	$V_{DS} = 20V, I_{D} = 90A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q_{gd}	_	14.2	_			
Turn-On Delay Time	t _{D(ON)}	_	9.5	_			
Turn-On Rise Time	t _R	_	6.7	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_D = 90A, R_G = 3.5\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	26.4	_	ns		
Turn-Off Fall Time	t _F	_	8.1	_			
Body Diode Reverse Recovery Time	t _{RR}	_	52.4	_	ns	L 500 di/dt 4000///-	
Body Diode Reverse Recovery Charge	Q_{RR}	_	78.2	_	nC	I _F = 50A, di/dt = 100A/μs	

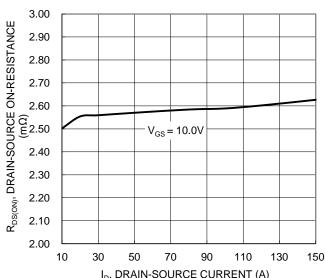
6. Device mounted with exposed drain pad on 25mm by 25mm 2oz copper on a single- sided 1.6mm FR-4 PCB; device is measured under still air conditions Notes: whilst operating in a steady state.

- 7. Thermal resistance from junction to solder point (on the exposed drain pin).
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.
- 10. Package limited.

DMTH4004SK3Q 2 of 7 October 2016 © Diodes Incorporated Document number: DS38660 Rev. 2- 2







I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

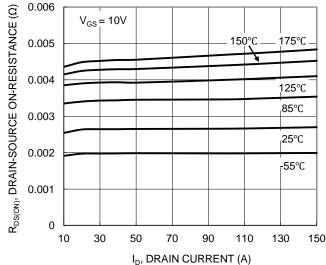


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

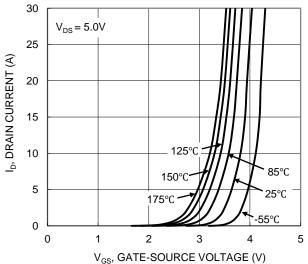


Figure 2. Typical Transfer Characteristic

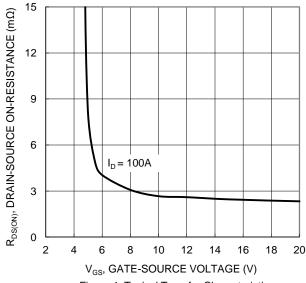
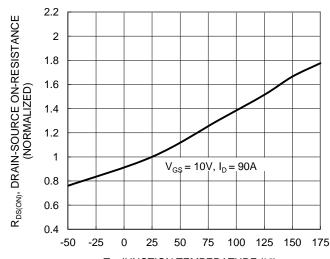


Figure 4. Typical Transfer Characteristic



T_., JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature



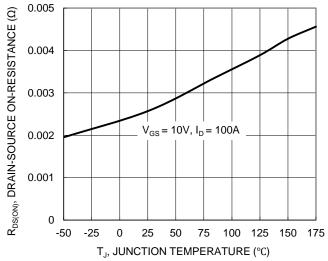


Figure 7. On-Resistance Variation with Temperature

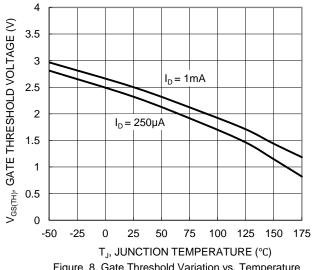


Figure 8. Gate Threshold Variation vs. Temperature

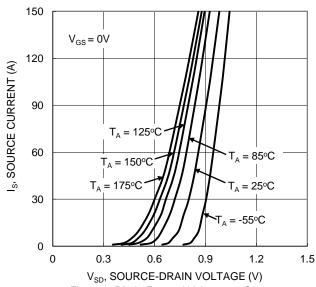
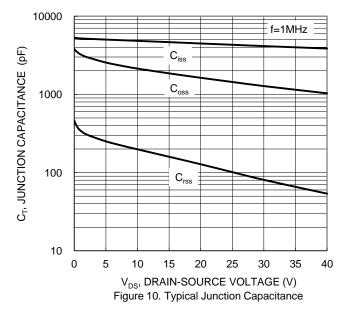


Figure 9. Diode Forward Voltage vs. Current



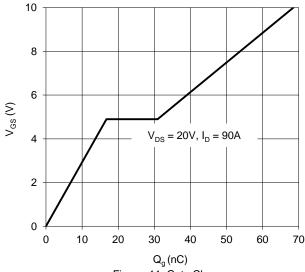
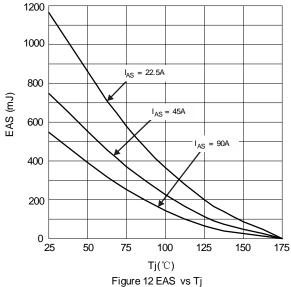


Figure 11. Gate Charge





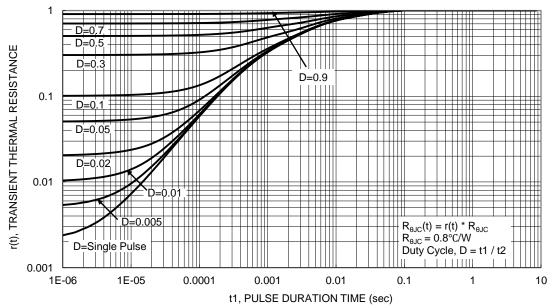


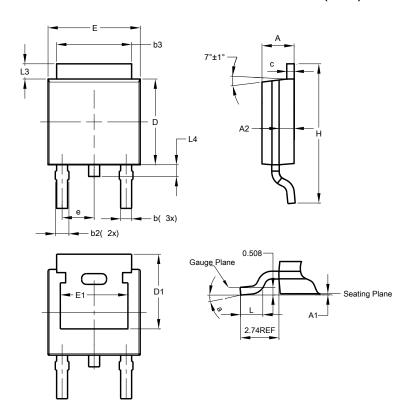
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

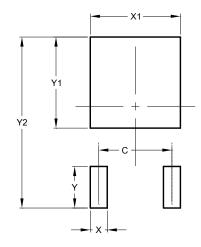


TO252 (DPAK)					
Dim	Min	Max	́Тур		
Α	2.19	2.39	2.29		
A 1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
q	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)		
С	4.572		
X	1.060		
X1	5.632		
Υ	2.600		
Y1	5.700		
Y2	10.700		



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